# Heraeus

# **Technical Data Sheet**



# THICK FILM MATERIALS

**Product Type:** Conductors

Product Name: C5729



#### Pb and Cd Free Gold Conductor

#### Description

C5729 is a Pb and Cd free, gold conductor paste that has been formulated for use with Al or Au wire bond applications.

#### **Key Benefits**

- Excellent Al and Au bondability
- High conductivity
- Fine line printing
- Pb and Cd free

# Recommended Processing Guidelines

#### Printing

280 mesh stainless steel screen 1.2 mil wire 45° angle 0.6 mil emulsion

# **Print Speed**

 $\geq$  4 in/sec ( $\geq$  10 cm/sec)

#### Settling

A settling time of 10-15 minutes is recommended. Parts should be dried as soon as possible after the settling period, (within 20 minutes), so the paste does not skin over. Parts should not be left out for long periods of time before drying. This allows the paste to skin over and can compromise adhesion. Wet parts should be covered if not dried right away.

#### **Drying**

150 °C for 10 minutes

Make sure ventilation is sufficient to prevent the wet film from skinning

#### Firing

850 °C peak temperature, 10 minutes at peak Total cycle time of 45 – 60 minutes

#### **Thickness**

Dried:  $20 - 22 \mu m$ Fired:  $8 - 11 \mu m$ 

#### Compatibility

IP9217, IP9227 and IP9117D Multilayer Dielectrics

#### **Thinner**

RV-372

#### Warranty

Material guaranteed to meet specifications for 6 months from date of shipment.

#### Storage

Store in a dry location at 5 - 25 °C.

#### DO NOT REFRIGERATE.

Allow paste to come to room temperature prior to opening. Spatulate well before using, as settling may occur during storage.



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# Typical Properties

### Resistivity

 $\leq 5.5~m\Omega/\square$  at 12  $\mu m$  fired film thickness using 25 mil wide serpentine conductor pattern

#### **Line Definition**

150 µm lines and spaces (6 mils)

#### Coverage

118 cm<sup>2</sup>/g at 12 μm fired film thickness (400 mesh, 0.9 mil wire, 0.5 mil emulsion)

#### Viscosity

380 – 480 Kcps, Brookfield HBT SC4-14 spindle and 6R utility cup at 10 rpm, 25 °C

#### Au Wire Bondability

2 mil wire 99.99 % Au, Elongation 3 – 5 % Initial: > 20 g

#### Solids

86.5 ± 1.0 %

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